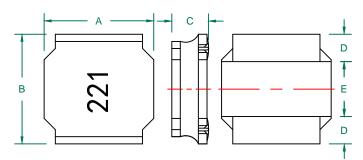
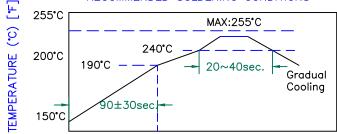
TYS6045221M-10

PHYSICAL DIMENSIONS:

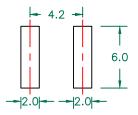
Α	6.00	±	0.30
В	6.00	±	0.30
С	4.50	+	0.20 0.30
D	1.80	±	0.30
F	2.40	4	0.30

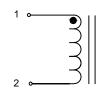


RECOMMENDED SOLDERING CONDITIONS



LAND PATTERNS FOR REFLOW SOLDERING

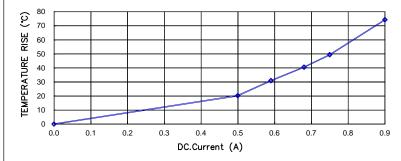




ELECTRICAL SPECIFICATION

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 20%	176	220	264
DCR (Ω)		0.834	1.084

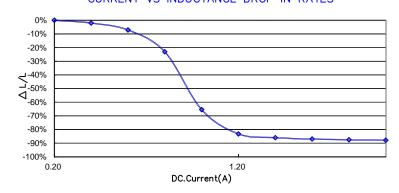
CHARACTERISTICS OF TEMPERATURE RISE





Saturation Current(A)	0.70
SRF (MHz)	3.5
Temperature Rise Current (A)	0.59

CURRENT VS INDUCTANCE DROP IN RATES



NOTES:

- 1.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)
- 3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS:
 A. AMBIENT TEMPERATURE: 20±15°C.
- B. RELATIVE HUMIDITY: 65%±20%.
- 4.SATURATION CURRENT IS THE DC CURRENT AT WHICH THE INDUCTANCE DROPS OFF APPROXIMATELY 30% FROM ITS VALUE WITHOUT CURRENT.(AMBIENT TEMPERATURE 25±5°C)
- 5. TEMPERATURE RISE CURRENT (IRMS):

DC CURRENT THAT CAUSES THE TEMPERATURE RISE (△T ≤40°C) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm .				This print is the property of Laird						
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		t		PROJECT/PART NUMBER:	- 10	REV	PART TY	rPE:	DRAWN BY:	
				TVC6045001M 10	. 1	С	l PO	WER		
С	MODIFY "C,D,E"	04/26/16	QIU	TYS6045221M-10	' I	C		CTOR	QIU	
В	CHANGE TEMP FROM -25℃~+125℃	12/24/12	QIU	DATE: 05/08/12	SCAL	SCALE: NTS		SHEET:		
Α	ORIGINAL DRAFT	05/08/12	QIU					ļ		
REV	DESCRIPTION	DATE	INT	ICAD # IO		_		1	of 1	
KEA	DESCRIP HON	DATE	11.4.1	1130043221M-10-C						